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Lee-Sup KIM, Chang-Hyo YU *12.8.03*  
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2. Name and address of receiving party(ies):  
Name: SAMSUNG ELECTRONICS CO., LTD.  
Internal Address: 416, Maetan-dong, Yeongtong-qu, Suwon-si, Gyeonggi-do, Republic of Korea  
Additional name(s) & address(es) attached:  Yes  No

03917 U.S. PTO  
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120803

3. Nature of conveyance:  
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Execution Date: November 26, 2003

4. Application number(s) or patent number(s): *10730226*  
If this document is being filed together with a new application, the execution date of the application is: November 26, 2003  
A. Patent Application No. (s) \_\_\_\_\_ B. Patent No. (s) \_\_\_\_\_  
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5. Name and address of party to whom correspondence concerning document should be mailed:  
Name: Frank Chau, Esq.  
Street Address: F. CHAU & ASSOCIATES, LLP  
1900 Hempstead Turnpike, Suite 501  
City: East Meadow State: NY Zip: 11554  
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6. Total number of applications and patents involved: 1  
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**ASSIGNMENT**

DOCKET NO.: 8021-199 (SS-20286-US)

AS A BELOW NAMED INVENTOR, I, and each of us, individually hereby declare that: IN CONSIDERATION of the sum of TEN (\$10.00) dollars or the equivalent thereof, and other good and valuable consideration, the receipt of which from the hereinafter named Assignee is hereby acknowledged, I do hereby sell, assign and forever grant and convey unto:

**ASSIGNEE:** Samsung Electronics Co., Ltd.

**ADDRESS:** 416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea

Who is my Assignee, and to the successes and assigns of my Assignee, all my right, title and interest, in and for the United States of America and all other countries, including all rights of priority, in and to the invention entitled:

**TITLE: 3D GRAPHICS RENDERING ENGINE FOR PROCESSING AN INVISIBLE FRAGMENT AND A METHOD THEREFOR**

invented by me (*if only one inventor is named below*) or us (*if more than one inventor is named below*) and described in an application for a United States patent the specification of which is either attached hereto or otherwise accompanies this Assignment or indicates an attorney docket no. 8021-199 (SS-20286-US), or is more particularly identified as:

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AND I hereby covenant and agree to sign and execute any further documents or instruments which may from time-to-time be either necessary, lawful, proper or requested by the Assignee, in the prosecution of the above-named application or in the preparation and prosecution of any certificate of correction, division, continuation, continuation-in-part, reissue, re-examination, in any amendment, extension, or interference proceeding, whether administrative or judicial, or otherwise, to secure the title hereto in said Assignee;

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